## SCHEMATICS



FRONT VIEW


PCB Layout
Viewed from Component Side


SIDE VIEW



$$
\text { DATE CODE: } \frac{Y Y Y W}{\uparrow} \frac{W}{\uparrow} \text { WEEK }
$$



DETAILA

MECHANICAL SPECIFICATIONS:

1. Housing \& insert material:
2. Contact material

PBT94V-0
3. Shield
4. Mating/unmating force
5. Retention strength
0.35 mm phosphor bronze 30u gold plating over nickel
: 0.20 mm thickness brass with nickel plated.
2.2kg. F MAX.

9 kg . F MIN between jack and plug.
6. Operating life

600 cycle MIN.
7. The part is recommended for wave soldering process, peak temp. is 265 degree $\mathrm{C}, 5$ seconds (see the wave soldering curve)
8. Jack cavity conforms with FCC part 68 subpart F (connector).

ENVIRONMENTAL SPECIFICATIONS:

1. Storage Temp. $:-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
2. Operation Temp. : $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$



## ELECTRICAL CIRCUIT



ELECTRICAL SPECIFICATIONS @ $25^{\circ} \mathrm{C}$ UNLESS OTHERWISE NOTED:

| Insertion Loss: | $1-100 \mathrm{MHZ}$$-1.0 \mathrm{~dB}$ MAX |  |
| :--- | :--- | :--- |
| Return Loss: | $1-30 \mathrm{MHZ}$ | -18.0 dB MIN |
|  | $30-60 \mathrm{MHZ}$ | -16.0 dB MIN |
|  | $60-80 \mathrm{MHZ}$ | -12.0 dB MIN |
|  | $80-100 \mathrm{MHZ}$ | -10.0 dB MIN |
| Crosstalk: | $10-30 \mathrm{MHZ}$ | -40.0 dB MIN |
|  | $30-60 \mathrm{MHZ}$ | -35.0 dB MIN |
|  | $60-100 \mathrm{MHZ}$ | -30.0 dB MIN |

Common Mode Rejection: $\quad 1-100 \mathrm{MHZ} \quad-30.0 \mathrm{~dB}$ MIN
Hipot:1500VAC 60S 1mA
OCL:350uH MIN@ 100KHZ 100mV 8mADC


| Dimensions:mm <br> Unless otherwise specified, all tolerances are $\pm 0,25$ | Approved By: TSLEE |  |
| :---: | :---: | :---: |
| 1000 BASE-T,Tab-Down Shielded, LEDs | Part No: WRJ-G111084NL | $\begin{gathered} \text { REV. } \\ \text { B } \end{gathered}$ |
|  |  | F 4 |

## Suggested Profile of Wave Solder for RoHS products



1. Maximum soldering temperature: $265^{\circ} \mathrm{C}$
2. Maximum soldering time: 5 seconds
3. SnAgCu or SAC , melting point is $219^{\circ} \mathrm{C}$
4. Any plastic components located under the Printed Circuit Board / Printed Wiring Board surface might be very slightly melted by recommended temperature profile. It will however, not affect the connector function. (For example, the plastic pins of the connector)


| Dimensions:mm <br> Unless otherwise specified, all tolerances are $\pm 0,25$ | Approved By: TSLEE |  |  |
| :--- | :--- | :--- | :--- |
| 1000 BASE-T, Tab- <br> Down Shielded, LEDs | Part No: WRJ-G111084NL | REV. <br> B |  |
|  |  | SHEET 3 | OF |

## PACKING


(Packing size: $300 \times 300 \times 400 \mathrm{~mm}$ )

1. The connectors are placed in a plastic tray in PPC recyclable material. Each tray contains 190 connectors. Each tray has a plastic cover in PPC recyclable material.
2. A carton sheet is placed on each side of the tray. The tray is then vacuum packed in a recyclable PE bag.
3. In each box there are 10 trays placed on top of each other. Each box contains total 1900 connectors.
4. Each box dimension is $300 \times 300 \times 400 \mathrm{~mm}$ or 0.036 CBM with a net weight of approximately 12.1 kg and a gross weight of approximately 13.5 kg .

